



	CPC1017N	Units
Load Voltage	60	V
Load Current	100	mA
Max R_{ON}	16	Ω
Current to operate	1.0	mA

Features

- Design for use in security systems complying with EN50130-4
- Only 1mA of LED current required to operate
- Small 4 Pin SOP Package
- TTL/CMOS Compatible input
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 1500V_{RMS} Input/Output Isolation/2100V AC peak
- No EMI/RFI Generation
- Immune to radiated EM fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available

Applications

- Security
 - Passive Infrared Detectors (PIR)
 - Data Signalling
 - Sensor Circuitry
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The CPC1017N is a miniature 1-Form-A solid state relay in a 4 pin SOP package that employs optically coupled MOSFET technology to provide 1500V of input to output isolation. The super efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED. The CPC1017N uses Clare's state-of-the-art double molded vertical construction packaging to produce the world's smallest relay. The CPC1017N offers board space savings of at least 20% over the competitor's larger 4 pin SOP relay. It boasts the industries' lowest input current to operate in its class.

Approvals

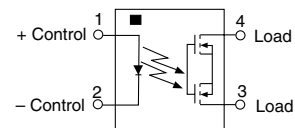
- UL Recognized Component
- BSI Certified to EN60950

Ordering Information

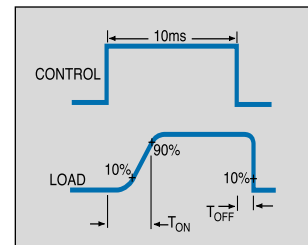
Part #	Description
CPC1017N	4 Pin SOP (100/tube)
CPC1017NTR	4 Pin SOP (2,000/reel)

Pin Configuration

CPC1017N Pinout



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	70	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	400 ¹	mW
Isolation Voltage Input to Output(AC Peak test voltage)	2100	-	-	V _{peak}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature (10 Seconds Max.)	-	-	+220	°C

¹ Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

Electrical Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Voltage (Peak)	I _L =1μA	V _L	-	-	60	V
Load Current (Continuous) AC Peak ¹	I _F =10mA	I _L	-	-	100	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance ²	I _L =100mA	R _{ON}	-	-	16	Ω
Off-State Leakage Current	V _L =60V	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	10	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	10	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	-	pF
Capacitance Input to Output	-	-	-	1	-	pF
Input Characteristics @ 25°C						
Input Control Current ³	I _L =150mA	I _F	1	-	50	mA
Input Dropout Current	-	I _F	0.3	0.9	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA

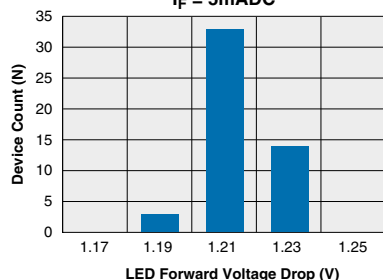
¹ Load current derates linearly from 100mA @ 25°C to 80mA @ 80°C.

² Measurement taken within 1 second of on time.

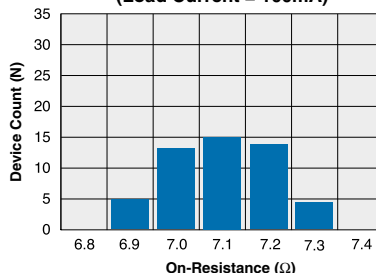
³ For applications requiring high temperature operation (greater than 60°C) an LED drive current of 3mA is recommended.

PERFORMANCE DATA*

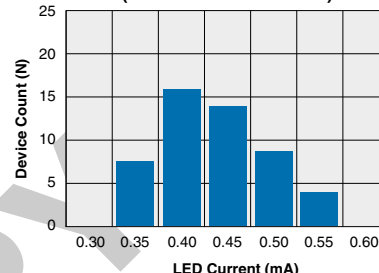
CPC1017N
Typical LED Forward Voltage Drop
 (Ambient Temperature = 25°C)
 $I_F = 5\text{mA}$



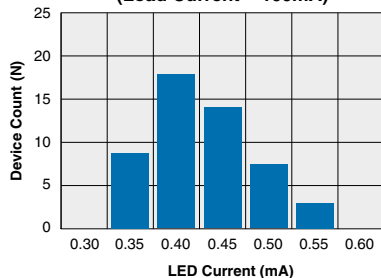
CPC1017N
Typical On-Resistance Distribution
 (Ambient Temperature = 25°C)
 (Load Current = 100mA)



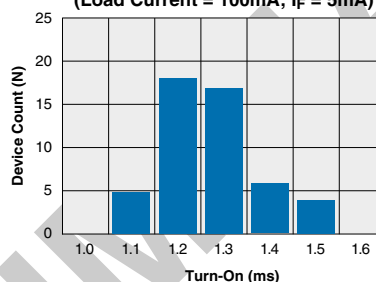
CPC1017N
Typical I_F for Switch Operation
 (Ambient Temperature = 25°C)
 (Load Current = 100mA)



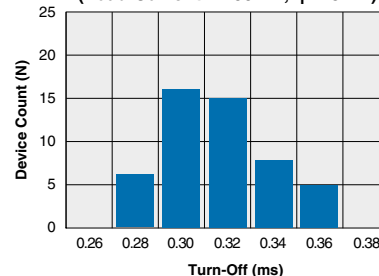
CPC1017N
Typical I_F for Switch Dropout
 (Ambient Temperature = 25°C)
 (Load Current = 100mA)



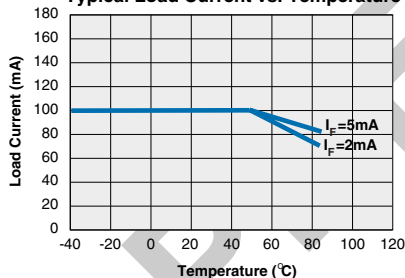
CPC1017N
Typical Turn-On Time
 (Ambient Temperature = 25°C)
 (Load Current = 100mA; $I_F = 5\text{mA}$)



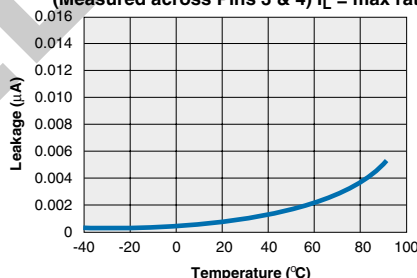
CPC1017N
Typical Turn-Off Time
 (Ambient Temperature = 25°C)
 (Load Current = 100mA; $I_F = 5\text{mA}$)



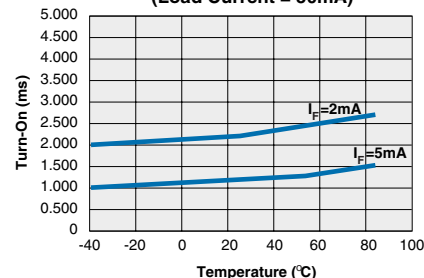
CPC1017N
Typical Load Current vs. Temperature



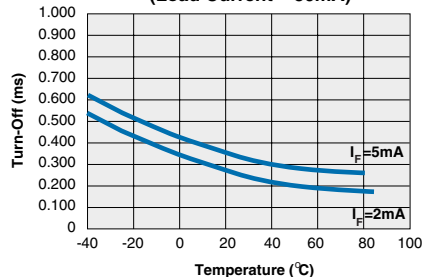
CPC1017N
Typical Leakage vs. Temperature
 (Measured across Pins 3 & 4) $I_L = \text{max rated}$



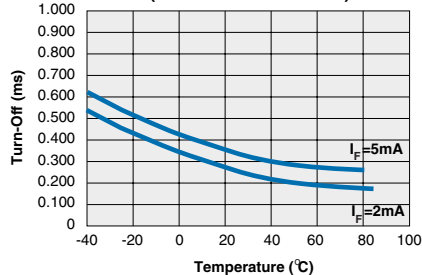
CPC1017N
Typical Turn-On vs. Temperature
 (Load Current = 50mA)



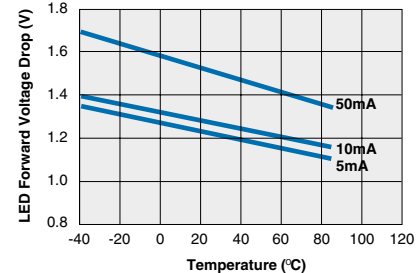
CPC1017N
Typical Turn-Off vs. Temperature
 (Load Current = 50mA)



CPC1017N
Typical Turn-Off vs. Temperature
 (Load Current = 50mA)



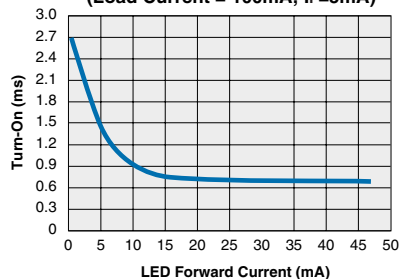
CPC1017N
Typical LED Forward Voltage Drop vs. Temperature



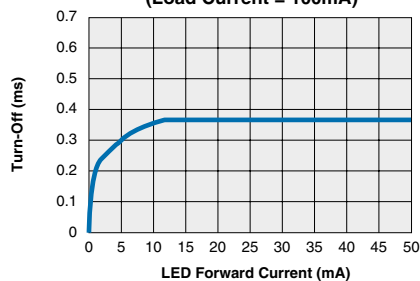
* The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*

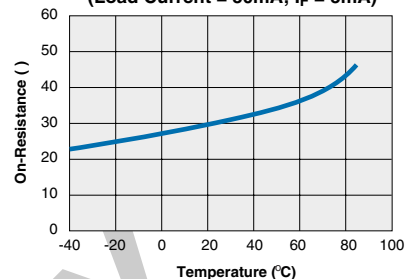
CPC1017N
Typical Turn-On vs. LED Forward Current
(Load Current = 100mA; $I_F = 5\text{mA}$)



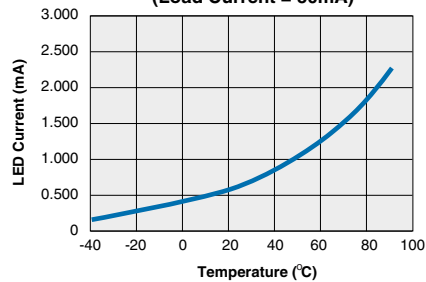
CPC1017N
Typical Turn-Off vs. LED Forward Current
(Load Current = 100mA)



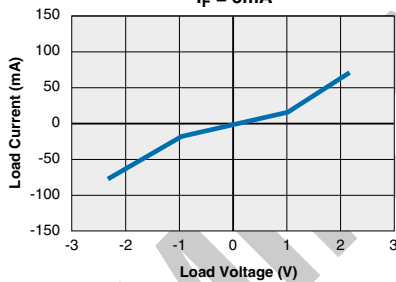
CPC1017N
Typical On-Resistance vs. Temperature
(Load Current = 50mA; $I_F = 5\text{mA}$)



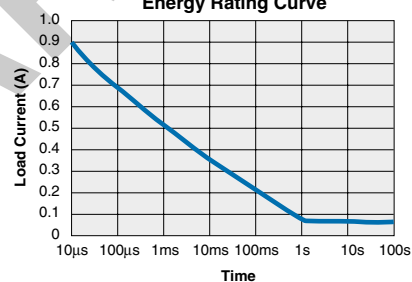
CPC1017N
Typical I_F for Switch Operation
vs. Temperature
(Load Current = 50mA)



CPC1017N
Typical Load Current vs. Load Voltage
(Ambient Temperature = 25°C)
 $I_F = 5\text{mA}$



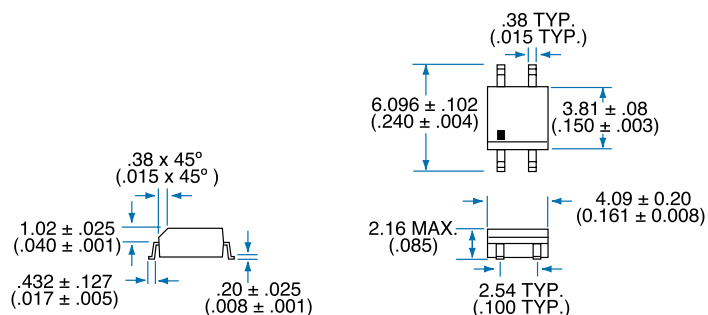
CPC1017N
Energy Rating Curve



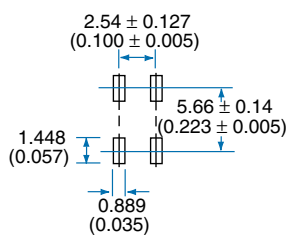
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MECHANICAL DIMENSIONS

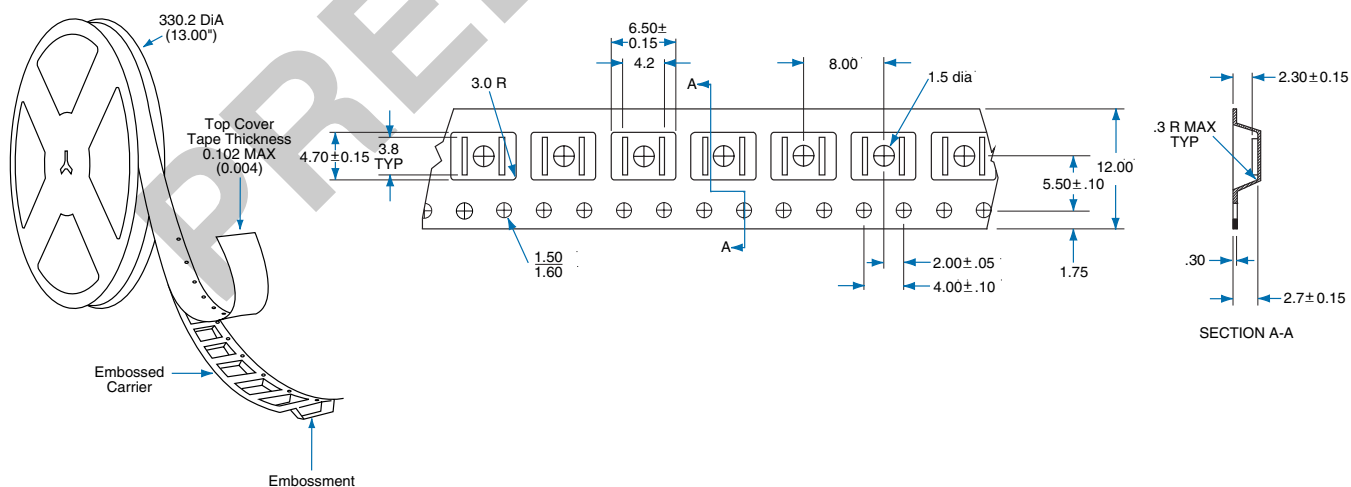
4 Pin SOIC Narrow ("N" Suffix)



PC Board Pattern (Top View)



Tape and Reel Packaging for 4 pin SOIC package



Dimensions
mm
(inches)



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